



HOSTAFORM® C 9021 GV1/30 GT

HOSTAFORM®

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988- POM-K, M-GNS2, 01-003, GF26 POM copolymer Injection molding type, reinforced with ca 26 % glass fibers; improved wear performance; high resistance to thermal and oxidative degradation; reduced thermal expansion and shrinkage. Ranges of applications: For molded parts requiring improved low wear performance while exhibiting very high strength and rigidity as well as higher hardness. FMVSS = Federal Motor Vehicle Safety Standard (USA) UL = Underwriters Laboratories (USA)

Product information

1 Toddet information	
Resin Identification POM Part Marking Code >POM	
Rheological properties	
Temperature 19	5 cm ³ /10min ISO 1133 0 °C 6 kg
0 0 1	3 % ISO 294-4, 2577
Moulding shrinkage, normal 0.	3 % ISO 294-4, 2577
Typical mechanical properties	
Tensile stress at break, 5mm/min 11 Tensile strain at break, 5mm/min 2.	O MPa ISO 527-1/-2 O MPa ISO 527-1/-2 O MPa ISO 527-1/-2 O MPa ISO 178
Flexural strength 11	MPa ISO 178
1,	5 kJ/m ² ISO 179/1eA 5 kJ/m ² ISO 179/1eA
Thermal properties	
Temperature of deflection under load, 1.8 MPa 15 Coefficient of linear thermal expansion 3 (CLTE), parallel	6 °C ISO 11357-1/-3 9 °C ISO 75-1/-2 0 E-6/K ISO 11359-1/-2
normal	
Physical/Other properties	
Density 154) kg/m ³ ISO 1183
Injection	
Drying Time, Dehumidified Dryer3 -Processing Moisture Content≤0.Melt Temperature Optimum20Min. melt temperature19Max. melt temperature21	0 °C 4 h 2 % 0 °C 0 °C 0 °C 3 m/s

Printed: 2025-05-30 Page: 1 of 4

Revised: 2024-07-16 Source: Celanese Materials Database





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Mold Temperature Optimum100 °CMin. mould temperature80 °CMax. mould temperature120 °CHold pressure range60 - 120 MPaBack pressure2 MPa

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent

Special characteristics Low wear / Low friction

Additional information

Injection molding Preprocessing

General drying is not necessary due to low moisture absorption of the resin.

In case of bad storage conditions (water contact or condensed water) the use of a recirculating air dryer (100 to 120 $^{\circ}$ C / max. 40 mm layer / 3 to 6 hours) is recommended.

Max. Water content 0,2 %

Processing

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

Printed: 2025-05-30 Page: 2 of 4

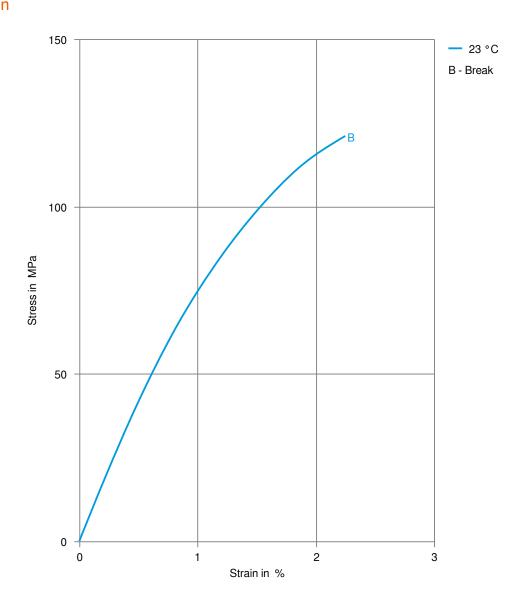
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HOSTAFORM® C 9021 GV1/30 GT HOSTAFORM®

Stress-strain



Printed: 2025-05-30 Page: 3 of 4

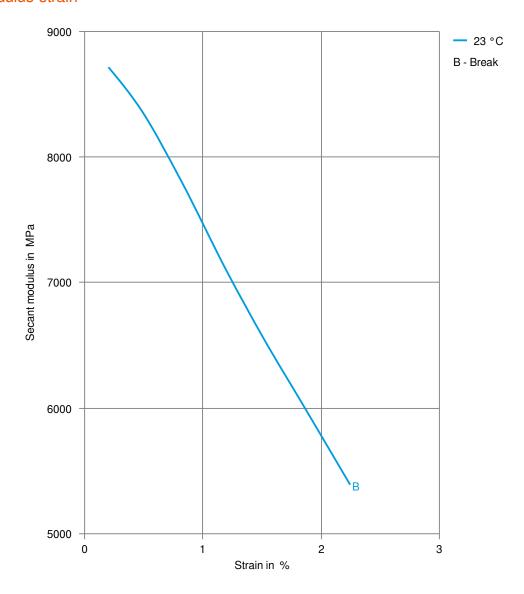




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Secant modulus-strain



Printed: 2025-05-30 Page: 4 of 4

Revised: 2024-07-16 Source: Celanese Materials Database

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